

IEEE 802.3 - Attendance and Affiliation Sheet

Pittsburgh, PA, USA - May 2015

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Fri	Credit
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1		4
Abughazaleh, Shadi	Hubbell Incorporated	Hubbell Incorporated	1	1	1	1		4
Amason, Dale	Freescall Semiconductor, Inc.	Freescall Semiconductor, Inc.	1	1	1	1		4
Andrewartha, J Michael	Microsoft Corporation	Microsoft Corporation			1	1	1	3
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	1	5
Arai, Tomoyuki	Socionext Inc.	Socionext Inc.	1	1	1	1		4
Babenko, Oleksandr	Molex Incorporated	Molex Incorporated	1	1	1	1		4
Baden, Eric	Broadcom Corporation	Broadcom Corporation	1	1	1	1	1	5
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1			3
Balasubramonian, Venugopal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	1	5
Baldwin, Thananya	Ixia	Ixia	1	1	1	1	1	5
Beia, Christian	STMicroelectronics	STMicroelectronics	1	1	1	1		4
Belopolsky, Yakov	Self Employed	Bel Stewart Connector	1	1	1			3
Bernstein, Gary	Leviton Manufacturing Co.	Leviton Manufacturing Co.		1	1			2
Bhatt, Vipul	Cisco Systems, Inc.	Inphi Corporation		1	1			2
Bliss, William	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Boiger, Christian	b-plus GmbH	b-plus GmbH	1					1
bolle, philippe	Skylane optics	skylane optics international	1	1				2
Booth, Brad	Microsoft Corporation	Microsoft Corporation			1	1	1	3
Bouda, Martin	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.	1	1				2
Bower, Patricia	Fujitsu Semiconductor Europe GmbH	FUJITSU		1				1
Brillhart, Theodore	Fluke Corporation	Fluke Corporation	1	1	1	1		4
Brooks, Paul	JDS Uniphase Corporation	JDS Uniphase Corporation	1	1	1	1		4
Brown, Matthew	Applied Micro (AMCC)	Applied Micro (AMCC)	1	1	1	1	1	5
Bullock, Chris	Cisco	Cisco		1	1	1		3
Butter, Adrian	IBM	IBM	1	1	1	1	1	5
Byrne, Joseph	Freescall Semiconductor, Inc.	freescale semiconductor	1	1	1			3
Caggioni, Francesco	AMCC	Applied Micro (AMCC)	1	1	1		1	4
Calderon, Juan-Carlos	Inphi	Inphi Corporation		1	1	1		3
Carlson, Steven	High-Speed Design Inc.	Broadcom Corporation	1	1	1	1	1	5

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Carroll, Martin	Verizon Communications	Verizon	1	1	1			3
Carty, Clark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1			3
Cates, Ron	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1		3
Chabot, Craig	University of New Hampshire InterO	University of New Hampshire InterO	1	1	1	1		4
Chacon Simon, Geoffrey	Hewlett-Packard Company	Hewlett-Packard Company	1	1	1	1	1	5
Chalupsky, David	Intel Corporation	Intel Corporation	1	1	1		1	4
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Chen, David	NSN, Inc.	Nokia Siemens Networks	1		1			2
Cheng, Wheling	Ericsson AB	Ericsson AB	1	1	1			3
Chini, Ahmad	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Chuang, Keng Hua	Hewlett-Packard Development Comp	Hewlett-Packard Development Comp	1	1	1	1	1	5
Cibula, Peter	Intel Corporation	Intel Corporation	1	1	1	1		4
Cober, Donald	CoMira Solutions, Inc.	CoMira Solutions, Inc.	1	1	1	1	1	5
Conroy, Keith	Multiphy	multiphy	1	1	1			3
Cui, zhenwei	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Dalmia, Kamal	Aquantia	Aquantia	1	1	1			3
D'Ambrosia, John	Dell	Dell	1	1	1	1		4
Darshan, Yair	Microsemi Corporation	Microsemi Corporation		1		1		2
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1	1	5
Dawson, Fred	Chemours Canada Company	Chemours Canada		1	1	1		3
DeBorde, William		Intel Corporation		1	1	1		3
Dedic, Ian	Fujitsu Semiconductor	Socionext Europe GmbH	1	1	1			3
Diab, Wael	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd				1	1	2
DiBiaso, Eric	TE Connectivity	TE Connectivity	1	1				2
Dillow, Daniel	FCI Electronics	FCI USA Inc.		1	1	1	1	4
Diminico, Christopher	M C Communications, LLC	Panduit	1	1		1		3
Dinh, Thuyen	Pulse Electronics	Pulse Electronics	1	1	1	1		4
Donahue, Curtis	University of New Hampshire InterO	UNH-IOL	1	1	1	1	1	5
Dove, Daniel	Dove Networking Solutions	Emulex -3by / Linear Technology -3b	1		1		1	3
Dudek, Michael	QLogic Corporation	QLogic Corporation	1	1	1	1	1	5

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Duer, Nick	General Cable Technologies Corpora	General Cable Technologies Corpora	1	1	1	1		4
Dwellely, David	Linear Technology	Linear Technology	1	1		1	1	4
Elbakoury, Hesham	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1	1	5
farjad, ramin	Aquantia	Aquantia Corp	1	1	1			3
Feldman, Shahar	Microsemi Corporation	Microsemi Corporation	1	1	1	1		4
Feyh, German	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Flatman, Alan	LAN Technologies Corporation, Inc.	LAN Technologies Corporation, Inc.	1	1	1			3
Frazier, Howard	Broadcom Corporation	Broadcom Corporation	1	1		1		3
Freeburn, Paul	Avaya Inc.	Avaya Inc.	1	1	1	1		4
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1	1	5
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,		1	1	1		3
Gardner, Andrew	Linear Technology	Linear Technology	1	1	1	1		4
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC	1	1	1	1		4
Goetzfried, Volker	Avago Technologies	Avago Technologies	1	1				2
Gong, Zhigang	O-Net Communications	O-Net Communications Ltd.	1	1	1	1		4
Gorshe, Steven	PMC-Sierra, Inc.	PMC-Sierra, Inc.	1	1	1	1	1	5
Graba, James	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Gravel, Mark	Hewlett-Packard Development Comp	Hewlett-Packard Company	1					1
Grow, Robert	RMG Consulting	RMG Consulting; KDPOF	1	1	1			3
Gustlin, Mark	Xilinx	Xilinx	1	1	1	1		4
Hajduczenia, Marek	Bright House Networks	Bright House Networks	1	1	1	1	1	5
Hall, Eric	Aurion	Aurion	1					1
Hamada, Mitsunori	Fujitsu Optical Components Limited	Fujitsu Optical Components Limited	1	1	1			3
Hamidy, Farid	Pulse Electronics	Pulse Electronics		1	1	1		3
Hammond, Bernard	TE Connectivity	TE Connectivity	1	1	1			3
Hansen, Per		OE Solutions		1	1			2
Healey, Adam	Avago Technologies	Avago Technologies	1	1	1	1	1	5
Hess, David	CORD DATA	CORD DATA	1	1	1	1		4
Hormmeyer, Bernd	Phoenix Contact	Phoenix Contact		1	1	1	1	4

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Fri	Credit
HYAKUTAKE, YASUHIRO	Adamant Co., Ltd.	Adamant Co., Ltd.	1	1	1			3
Ingham, Jonathan	Avago Technologies	Avago Technologies	1	1	1	1	1	5
Irwin, Scott	MoSys, Inc.	MoSys, Inc.	1	1	1	1	1	5
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1			3
Issenhuth, Tom	Microsoft Corporation	Microsoft Corporation	1	1	1			3
Jackson, Kenneth	Sumitomo Electric Device Innovation	Sumitomo Electric Industries, LTD	1	1	1	1		4
Johnson, Peter	Sifos Technologies	Sifos Technologies		1	1	1		3
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		1	4
Jorio, ismail	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
JOSEPH, ANTONY	NXP Semiconductors	NXP Semiconductors	1	1	1	1		4
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	1	5
KAWAHARA, KEISUKE	Furukawa Electric	Furukawa Electric	1	1	1	1	1	5
Kelsen, Michael	Time Warner Cable Inc.	Time Warner Cable Inc.	1	1				2
Kilduff, Rick		JDS Uniphase Corporation			1			1
Kim, Yongbum	Broadcom Corporation	Broadcom Corporation	1	1	1			3
King, Jonathan	Finisar Corporation	Finisar Corporation	1		1	1	1	4
Kipp, Scott	Brocade Communications Systems, Inc.	Brocade Communications Systems, Inc.	1	1	1			3
Klaus, Andrew	Marvell Semiconductor, Inc.	JASPAR; Marvell Semiconductor, Inc.	1		1	1		3
Klempa, Michael	University of New Hampshire InterO	University of New Hampshire InterO	1	1	1	1		4
Knittle, Curtis	Cable Television Laboratories Inc. (Ca	Cable Television Laboratories Inc. (Ca		1	1			2
Kobayashi, Shoukei	NTT Communications	Nippon Telegraph and Telephone Co	1	1	1	1	1	5
Koftinoff, Jeff	J.D. Koftinoff Software, Ltd.	Meyer Sound Laboratories, Inc.	1					1
Kojima, Keisuke	Mitsubishi Electric Research Labs (M	Mitsubishi Electric Research Labs (M	1	1	1	1		4
Kolesar, Paul	CommScope, Inc.	CommScope, Inc.	1	1	1			3
Kolze, Tom	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Kountz, Dennis	The Chemours Company	DuPont	1			1		2
Lane, Brett	Panduit Corp.	Panduit Corp.		1	1			2
Langhammer, Martin	Altera Corporation	Altera Corporation		1	1			2
Lapak, Jeff	University of New Hampshire InterO	University of New Hampshire InterO	1	1	1	1	1	5

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Latchman, Ryan	MACOM	MACOM	1	1	1	1		4
Lau, Evan	General Cable Technologies Corpora	General cable	1	1	1			3
Laubach, Mark	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Law, David	Hewlett-Packard Ltd	Hewlett-Packard Ltd	1	1	1	1	1	5
Le Cheminant, Greg	Agilent Technologies, Inc.	Keysight Technologies	1	1	1	1		4
Lewis, David	JDS Uniphase Corporation	JDS Uniphase Corporation	1	1	1		1	4
Lewis, Jon	Dell	Dell	1	1	1	1		4
Li, Mike-Peng	Altera Corporation	Altera Corporation	1	1	1	1		4
Li, Shaohua	Brocade Communications Systems, I	Brocade Communications Systems, I	1	1	1	1		4
Li, Yizhou	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1					1
Lingle, Robert	OFS	OFS	1	1				2
Lo, William	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1			3
Loughnan, Dylan	Firecomms Ltd.	Firecomms Ltd.	1	1				2
Lukacs, Miklos	Silicon Laboratories	Silicon Laboratories	1	1	1	1		4
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1			3
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1		4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	1	5
Malette, Edwin	Bright House Networks	Bright House Networks	1	1	1			3
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.	1	1	1	1	1	5
Matoglu, Erdem	Amphenol Corporation	Amphenol Corporation			1	1		2
Matola, Laurence	Delphi Corporation	Delphi Corporation	1	1	1	1		4
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1		4
Mcdermott, Thomas	FUJITSU	Fujitsu	1	1	1	1		4
McDonough, John	NEC Corporation	NEC America		1	1	1	1	4
McSorley, Gregory	Amphenol Corporation	Amphenol Corporation		1		1		2
Mei, Richard	CommScope, Inc.	CommScope, Inc.	1	1	1	1	1	5
Mellitz, Richard	Intel Corporation	Intel Corporation	1	1	1	1	1	5
Moffitt, Bryan	CommScope, Inc.	CommScope, Inc.	1	1	1	1		4
Mooney, Paul	Spirent Communications	Spirent Communications	1	1	1			3
Murray, Dale	LightCounting	LightCounting LLC	1	1	1			3

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Nakamoto, Edward	Spirent Communications	Spirent Communications	1	1	1	1		4
Nelson, John		Arista Networks			1	1	1	3
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1		2
Nielsen, Allan	TE Connectivity	TE Connectivity	1	1	1	1		4
Noll, Kevin	Time Warner Cable Inc.	Time Warner Cable Inc.		1	1			2
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	1	5
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1		4
Ogura, Ichiro	PETRA	PETRA		1	1			2
Palkert, Thomas	EIC	Luxtera-Molex-MoSys		1	1	1	1	4
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1		4
PARK, MOON	OE Solutions	oe solutions	1	1	1			3
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation	1	1				2
Pepper, Gerald	Ixia	Ixia	1	1	1	1	1	5
Perez De Aranda Alonso, Ruben	KDPOF	KDPOF	1	1	1			3
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1	1	1	1	5
Pienciak, Walter	IEEE - Institute of Electrical and Elect	IEEE Standards Association (IEEE-SA)	1					1
Pimpinella, Rick	Panduit Corp.	Panduit Corp.	1	1	1			3
Porach, Stephen	Optical Cable Corporation (OCC)	Optical Cable Corporation (OCC)	1	1	1			3
Powell, William	ALCATEL-LUCENT	ALCATEL-LUCENT	1	1	1	1		4
Prodan, Richard	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Rabinovich, Rick	ALCATEL-LUCENT	ALE	1	1	1	1	1	5
Rahman, Saifur	Comcast	Comcast	1	1	1			3
RAN, ADEE	Intel Corporation	Intel Corporation	1	1	1	1		4
Regev, Alon	Ixia	Ixia	1	1	1	1	1	5
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1	1		4
Renteria, Victor	Bel Fuse	Bel Fuse	1	1	1	1		4
Ressl, Michael	Hitachi, Ltd.	Hitachi Cable America Inc.	1	1	1			3
Rimboim, Poldi	Microsemi Corporation	Microsemi Corporation		1	1	1		3
Roszbach, Martin	Nexans Cabling Solutions	Nexans SA	1	1	1			3
Roth, Christopher	Molex Incorporated	Molex Incorporated	1	1	1	1	1	5

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Rotolo, Salvatore	STMicroelectronics	STMicroelectronics	1	1	1	1	1	5
Sakai, Toshiaki		Socionext		1	1	1		3
Sakamoto, Hisaya	Fujitsu Optical Components Limited	Fujitsu Optical Components	1	1	1			3
Salunke, Vineet	Cisco Systems, Inc.	Cisco Systems, Inc.	1		1	1		3
Sambasivan, Sam	AT&T	AT&T	1	1	1	1		4
Satake, Toshiaki		US Conec, Ltd.	1	1	1	1		4
Schicketanz, Dieter	Consultant	CONSULTANT; Leoni kerpen	1	1	1	1		4
Schindler, Fred	Seen Simply	Seen Simply		1	1	1	1	4
Schneelee, Stefan	Airbus Group	Airbus Group	1	1	1	1	1	5
Schube, Scott	Intel Corporation	Intel Corporation	1		1			2
Scruton, Peter	University of New Hampshire InterO	University of New Hampshire InterO	1	1	1	1		4
Sedarat, Hossein	Aquantia	Aquantia	1	1	1			3
Sella, Omer	Mellanox Technologies	Mellanox Technologies	1	1	1	1	1	5
SERIZAWA, NAOSHI	Yazaki Corporation	Yazaki Corporation	1	1	1	1		4
SHAMI, QASIM	CoMira Solutions Inc	Comira Solutions	1			1	1	3
Shanbhag, Megha	Tyco Electronics Corporation	TE Connectivity	1	1	1	1		4
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1		4
shirani, ramin	Aquantia corporation	aquantia corporation	1	1	1			3
Shirao, Mizuki	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation	1	1	1	1		4
Shrikhande, Kapil	Dell	Dell			1	1	1	3
Slavick, Jeff	Avago Technologies	Avago Technologies			1	1	1	3
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1		4
Sone, Yoshiaki	NTT	Nippon Telegraph and Telephone Co	1	1	1	1	1	5
Souvignier, Tom	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Sparacin, Daniel	Aurion	Aurion	1					1
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.		1	1	1		3
Sprague, Edward	Infinera Corporation	Infinera Corporation	1	1	1			3
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Stone, Robert	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Su, Ching-Yao	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	1	1			3

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Sugitatsu, Atsushi	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation	1	1	1	1		4
Sun, Junqing	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	1	5
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1	1	1	5
Szczepanek, Andre	Inphi Corporation	Inphi Corporation	1	1	1	1		4
Szeto, William	Xtera Communications	xtera	1	1	1			3
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation	1	1	1	1		4
Tajima, Takayuki	Yazaki corporation	YAZAKI corporation	1	1	1	1		4
TAKAHARA, TOMOO	Fujitsu Optical Components Limited	FUJITSU LABORATORIES LIMITED	1	1	1			3
Takahashi, Satoshi	Self Employed	Self Employed	1	1	1	1		4
Takahata, Kiyoto	Nippon Telegraph and Telephone Co	NTT	1	1	1	1		4
Takai, Atsushi	Oclaro	Oclaro, Inc	1	1	1			3
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.	1	1	1	1		4
Tanaka, Toshiki	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1			3
Ten, Sergey	Corning Incorporated	Corning Incorporated	1	1				2
Thaler, Patricia	Broadcom Corporation	Broadcom Corporation	1		1	1		3
Thompson, Geoffrey	Linear Technology	Linear Technology	1	1	1	1		4
Thrybom, Linus		ABB AB, Corporate Research			1			1
Tipper, Alan	Semtech	Semtech	1	1	1	1		4
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	1	5
Tremblay, David	Hewlett-Packard Ltd	Hewlett-Packard Company		1	1	1		3
Tretter, Albert	Siemens AG	Siemens AG	1	1	1	1	1	5
Trowbridge, Stephen	ALCATEL-LUCENT	ALCATEL-LUCENT	1	1	1	1	1	5
Tsukamoto, Yoshihiro	Mitsubishi Rayon Co. Ltd.	Mitsubishi Rayon Co., Ltd.	1	1	1			3
Tu, Mike	Broadcom Corporation	Broadcom Corporation	1	1	1	1		4
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1			3
Vaden, Sterling	Vaden Enterprises	Vaden Enterprises	1	1	1	1	1	5
Vanderlaan, Paul	Nexans Canada Inc.	Berk-Tek LLC	1	1	1	1		4
VITTAL, BALASUBRAMANIAN	Dell	Dell	1	1	1	1		4
Wagner, Robert	Panduit Corp.	Panduit Corp.	1	1	1			3
Walker, Clinton	Intel Corporation	Intel Corporation		1	1	1		3

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Walker, Dylan	Cisco	Cisco		1	1	1		3
wang, haifei	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Wang, Roy	Hewlett-Packard Ltd	Hewlett-Packard Company	1	1	1	1	1	5
Wang, Tongtong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1			3
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated	1	1	1	1		4
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
WANG, ZHONG FENG	Broadcom Corporation	Broadcom Corporation	1	1	1			3
Weber, Markus	Socionext Europe GmbH	Socionext Europe GmbH	1	1	1			3
Welch, Brian	Luxtera	Luxtera	1	1	1			3
Wendt, Matthias	Philips Electronics	Philips Electronics	1	1	1	1	1	5
Wertheim, Oded	Mellanox Technologies	Mellanox Technologies	1	1	1	1	1	5
white, martin	Cavium Networks	Cavium Networks	1	1	1	1	1	5
Wienckowski, Natalie	General Motors Company	General Motors Company			1	1		2
Winkel, Ludwig	Siemens AG	Siemens AG		1	1			2
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1			3
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
YI, JUN		Champlain Cable Company		1	1	1		3
Yseboodt, Lennart	Philips Electronics	Philips Electronics	1	1	1	1		4
YUKI, HAYATO	AutoNetworks Technologies, Ltd	AutoNetworks Technologies Ltd.	1	1	1	1	1	5
Zambell, Andrew	FCI USA Inc.	FCI USA Inc.			1	1		2
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1		4
Zimmerman, George	CME Consulting	Aquantia, CommScope, Inc. & LTC	1	1	1	1		4